

SN75ALS056, SN75ALS057 TRAPEZOIDAL-WAVEFORM INTERFACE BUS TRANSCEIVERS

SLLS028G – AUGUST 1987 – REVISED JUNE 1998

- Suitable for IEEE Standard 896 Applications†
- SN75ALS056 is an Octal Transceiver
- SN75ALS057 is a Quad Transceiver
- High-Speed Advanced Low-Power Schottky (ALS) Circuitry
- Low Power Dissipation:
52.5 mW/Channel Max
- High-Impedance pnp Inputs
- Logic-Level 1-V Bus Swing Reduces Power Consumption
- Trapezoidal Bus Output Waveform Reduces Noise Coupling to Adjacent Lines
- Power-Up/Power-Down Protection (Glitch Free)
- Open-Collector Driver Outputs Allow Wired-OR Connections
- Designed to Be a Faster, Lower-Power Functional Equivalent of National DS3896, DS3897

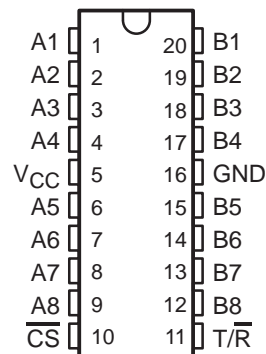
description

The SN75ALS056 is an eight-channel, monolithic, high-speed, advanced low-power Schottky (ALS) device designed for two-way data communication in a densely populated backplane. The SN75ALS057 is a four-channel version with independent driver-input (Dn) and receiver-output (Rn) pins and a separate driver disable for each driver (En).

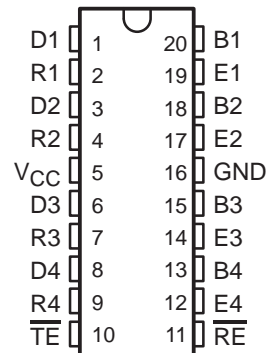
These transceivers feature open-collector driver outputs with series Schottky diodes to reduce capacitive loading to the bus. By using a 2-V pullup termination on the bus, the output signal swing is approximately 1 V, which reduces the power necessary to drive the bus load capacitance. The driver outputs generate trapezoidal waveforms that reduce crosstalk between channels. The drivers are capable of driving an equivalent dc load as low as 18.5 Ω. The receivers have internal low-pass filters to further improve noise immunity.

The SN75ALS056 and SN75ALS057 are characterized for operation from 0°C to 70°C.

SN75ALS056 . . . DW OR N PACKAGE
(TOP VIEW)



SN75ALS057 . . . DW OR N PACKAGE
(TOP VIEW)



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

† The transceivers are suitable for IEEE Standard 896 applications to the extent of the operating conditions and characteristics specified in this data sheet.

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

 **TEXAS
INSTRUMENTS**

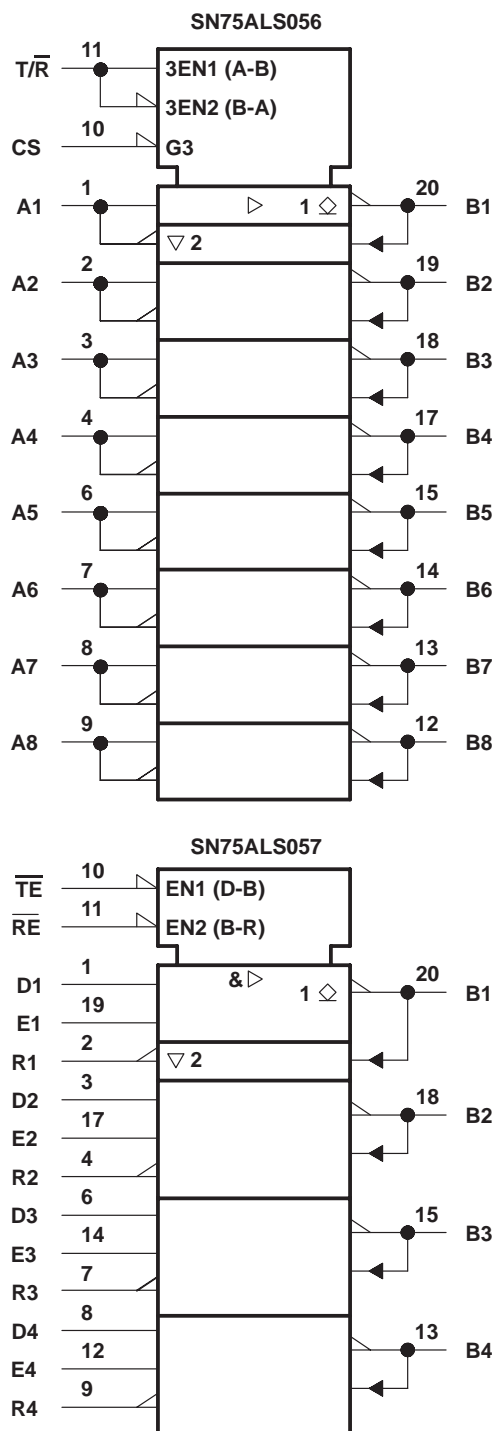
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logic symbol†

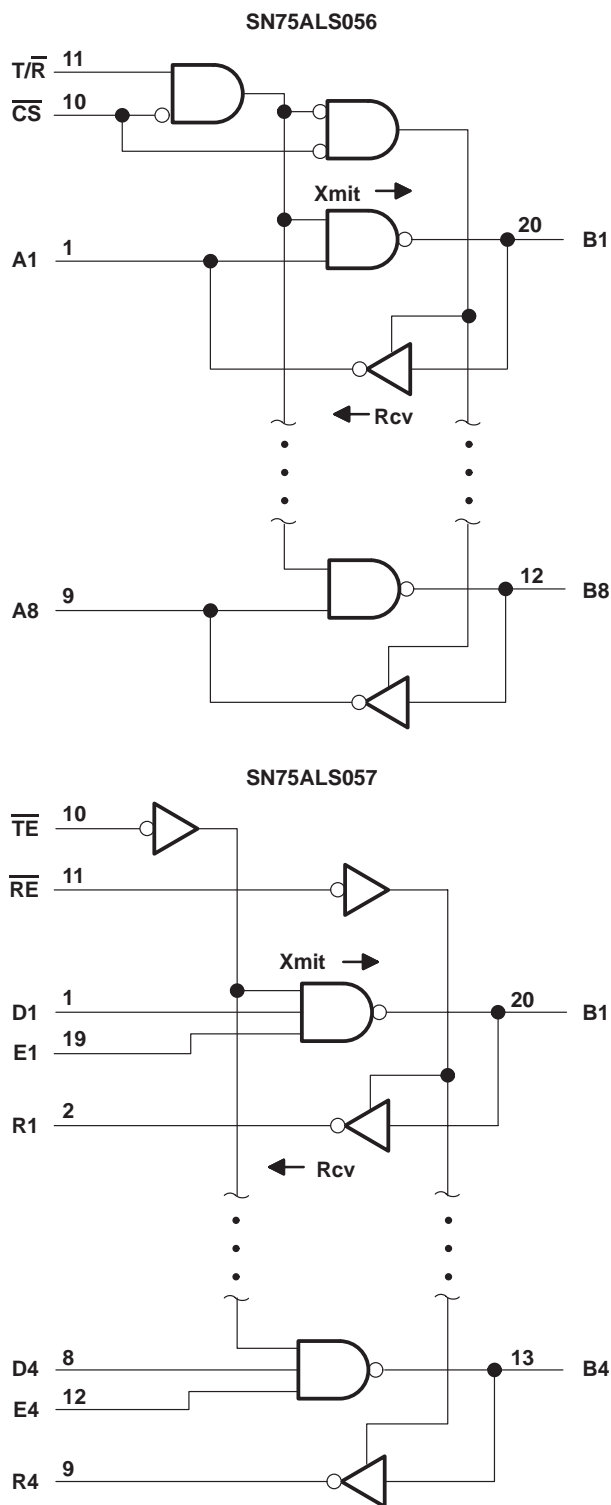


† These symbols are in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

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logic diagram (positive logic)



† These symbols are in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

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Function Tables

SN75ALS056 TRANSMIT/RECEIVE

CONTROLS		CHANNELS
\overline{CS}	T/\overline{R}	A \leftrightarrow B
L	H	T(A B)
L	L	R(B A)
H	X	D

SN75ALS057 TRANSMIT/RECEIVE

CONTROLS			CHANNELS			
\overline{TE}	\overline{RE}	En	D	B	B	R
L	L	L	D			R
L	L	H	T			R
L	H	L	D			D
L	H	H	T			D
H	L	X	D			R
H	H	X	D			D

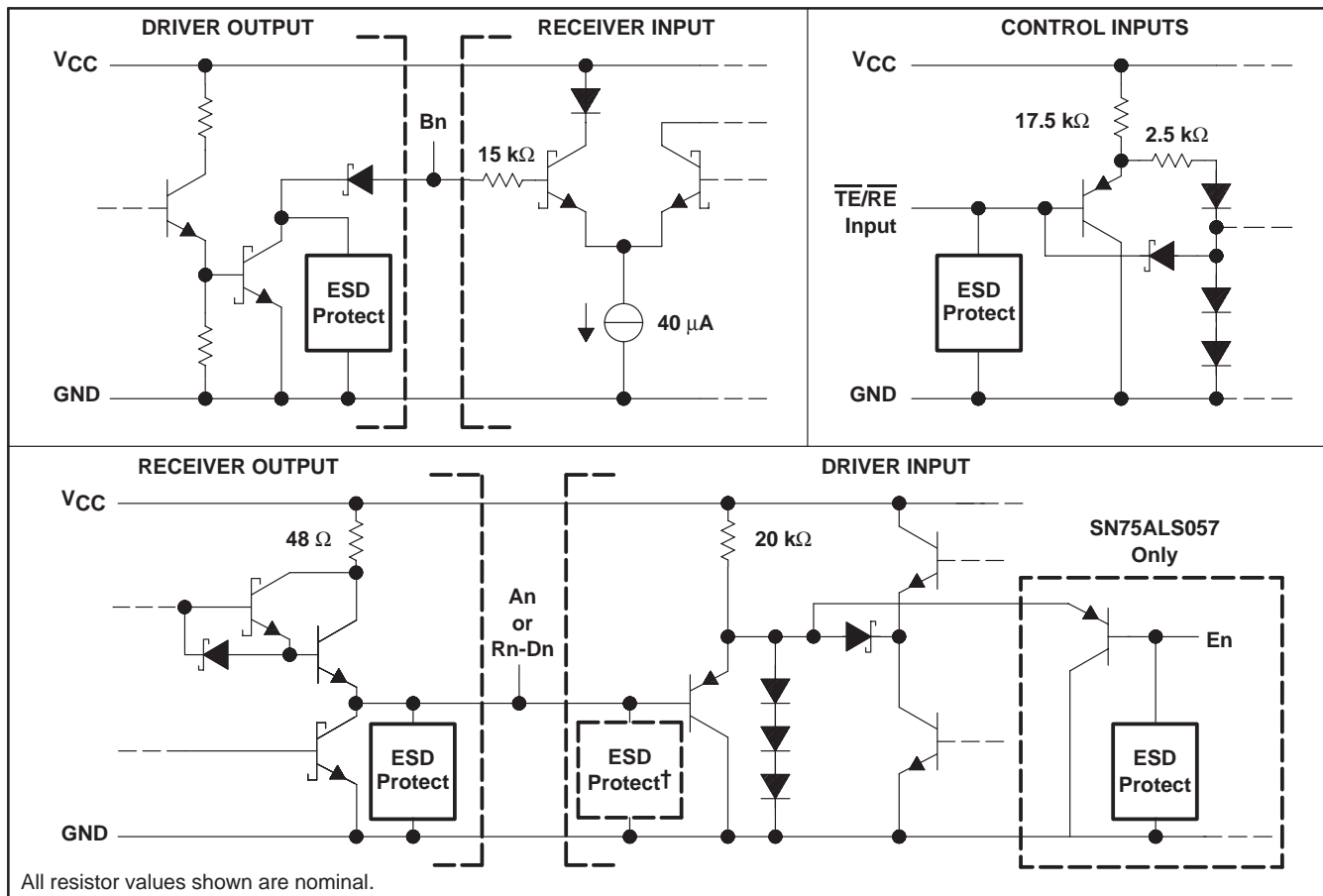
H = high level, L = low level, R = receive, T = transmit,
D = disable, X = irrelevant

Direction of data transmission is from An to Bn for the SN75ALS056 and from Dn to Bn for the SN75ALS057. Direction of data reception is from Bn to An for the SN75ALS056 and from Bn to Rn for the SN75ALS057. Data transfer is inverting in both directions.

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schematics of inputs and outputs



† Additional ESD protection is on the SN75ALS057, which has separate receiver-output and driver-input pins.

absolute maximum ratings over operating free-air temperature (unless otherwise noted)‡

Supply voltage, V_{CC} (see Note 1)	6 V
Control input voltage, V_I	5.5 V
Driver input voltage, V_I	5.5 V
Driver output voltage, V_O	2.5 V
Receiver input voltage, V_I	2.5 V
Receiver output voltage, V_O	5.5 V
Continuous total power dissipation	See Dissipation Rating Table
Storage temperature range, T_{stg}	-65°C to 150°C
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds: DW or N package	260 °C

‡ Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: Voltage values are with respect to network ground terminal.

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DISSIPATION RATING TABLE

PACKAGE	$T_A \leq 25^\circ\text{C}$ POWER RATING	DERATING FACTOR ABOVE $T_A = 25^\circ\text{C}$	$T_A = 70^\circ\text{C}$ POWER RATING	$T_A = 125^\circ\text{C}$ POWER RATING
DW	1025 mW	8.2 mW/ $^\circ\text{C}$	656 mW	—
N	1150 mW	9.2 mW/ $^\circ\text{C}$	736 mW	—

recommended operating conditions

	MIN	NOM	MAX	UNIT
Supply voltage, V_{CC}	4.75	5	5.25	V
High-level driver and control input voltage, V_{IH}	2			V
Low-level driver and control input voltage, V_{IL}			0.8	V
Bus termination voltage	1.9		2.1	V
Operating free-air temperature, T_A	0		70	$^\circ\text{C}$

electrical characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

PARAMETER		TEST CONDITION [†]	SN75ALS056			UNIT
			MIN	TYP [†]	MAX	
V_{IK}	Input clamp voltage at An, $\overline{T/R}$, or \overline{CS}	$I_I = -18 \text{ mA}$			-1.5	V
V_{IT}	Receiver input threshold voltage at Bn		1.405		1.69	V
V_{OH}	High-level output voltage at An	Bn at 1.2 V, \overline{CS} at 0.8 V, $\overline{T/R}$ at 0.8 V, $I_{OH} = -400 \mu\text{A}$	2.4			V
V_{OL}	Low-level output voltage	An			0.5	V
		Bn	An at 2 V, \overline{CS} at 0.8 V, $\overline{T/R}$ at 2 V, $V_L = 2 \text{ V}$, $R_L = 18.5 \Omega$, See Figure 1	0.75	1.2	
I_{IH}	High-level input current	An, $\overline{T/R}$ or \overline{CS}			40	μA
		Bn	$V_I = 2 \text{ V}$, $V_{CC} = 0 \text{ or } 5.25 \text{ V}$, An at 0.8 V, $\overline{T/R}$ at 0.8 V		100	
I_{IL}	Low level input current at An, $\overline{T/R}$, or \overline{CS}	$V_I = 0.4 \text{ V}$			-400	μA
I_{OS}	Short-circuit output current at An	An at 0, Bn at 1.2 V, \overline{CS} at 0.8 V, $\overline{T/R}$ at 0.8 V	-40		-120	mA
I_{CC}	Supply current				75	mA
$C_{O(B)}$	Driver output capacitance				4.5	pF

[†] Typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^\circ\text{C}$.



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electrical characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

PARAMETER		TEST CONDITIONS	SN75ALS057			UNIT
			MIN	TYP†	MAX	
V _{IK}	Input clamp voltage at Dn, En, \overline{TE} , or \overline{RE}	I _I = -18 mA			-1.5	V
V _{IT}	Receiver input threshold voltage at Bn		1.41		1.69	V
V _{OH}	High-level output voltage at Rn	Bn at 1.2 V, \overline{RE} at 0.8 V, I _{OH} = -400 μA	2.4			V
V _{OL}	Low-level output voltage	Rn			0.5	V
		Bn	Dn at 2 V, En at 2 V, \overline{TE} at 0.8 V, V _L = 2 V, R _L = 18.5 Ω, See Figure 1	0.75	1.2	
I _{IH}	High-level input current	Dn, En, \overline{TE} , or \overline{RE}			40	μA
		Bn	V _I = V _{CC} V _I = 2 V, V _{CC} = 0 or 5.25 V, Dn at 0.8 V, En at 0.8 V, \overline{TE} at 0.8 V		100	
I _{IL}	Low-level input current at Dn, En, \overline{TE} , or \overline{RE}	V _I = 0.4 V			-400	μA
I _{OS}	Short-circuit output current at Rn	Rn at 0, Bn at 1.2 V, \overline{RE} at 0.8 V	-40		-120	mA
I _{CC}	Supply current				40	mA
C _{O(B)}	Driver output capacitance				4.5	pF

† Typical values are at V_{CC} = 5 V, T_A = 25°C.

switching characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	SN75ALS056 DRIVER			UNIT
				MIN	TYP†	MAX	
t _{PLH1}	\overline{CS}	Bn	An and T/ \overline{R} at 2 V, V _L = 2 V, R _{L1} = 18 Ω, C _L = 30 pF, R _{L2} not connected, See Figure 2			24	ns
t _{PHL1}						20	
t _{PLH2}	An	Bn	\overline{CS} at 0.8 V, T/ \overline{R} at 2 V, V _L = 2 V, R _{L1} = 18 Ω, R _{L2} not connected, C _L = 30 pF, See Figure 2,			19	ns
t _{PHL2}						18	
t _{PLH3}	T/ \overline{R}	Bn	V _I (An) = 5 V, \overline{CS} at 0.8 V, R _{L1} = 18 Ω, C _L = 30 pF, R _{L2} not connected, V _L = 2 V, See Figure 3,			25	ns
t _{PHL3}						35	
t _{TLH}	An	Bn	\overline{CS} at 0.8 V, T/ \overline{R} at 2 V, V _L = 2 V, C _L = 30 pF, R _{L1} = 18 Ω, R _{L2} not connected, See Figure 2	1	3	11	ns
t _{THL}				1	3	6	

† Typical values are at V_{CC} = 5 V, T_A = 25°C



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switching characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	SN75ALS056 RECEIVER		UNIT
				MIN	MAX	
t _{PLH4}	Bn	An	\overline{CS} at 0.8 V, T/ \overline{R} at 0.8 V, R _{L1} = 390 Ω, R _{L2} = 1.6 kΩ, C _L = 30 pF, See Figure 4	18		ns
t _{PHL4}				18		
t _{PLZ1}	T/ \overline{R}	An	\overline{CS} at 0.8 V, V _{I(Bn)} = 2 V, V _L = 5 V, R _{L1} = 390 Ω, R _{L2} not connected, C _L = 15 pF, See Figure 3	20		ns
t _{PZL1}	T/ \overline{R}	An	\overline{CS} at 0.8 V, V _{I(Bn)} = 2 V, V _L = 5 V, R _{L1} = 390 Ω, R _{L2} = 1.6 kΩ, C _L = 30 pF, See Figure 3	40		ns
t _{PHZ1}	T/ \overline{R}	An	\overline{CS} at 0.8 V, V _{I(Bn)} = 0, V _L = 0, R _{L1} = 390 Ω, R _{L2} not connected, C _L = 15 pF, See Figure 3	17		ns
t _{PZH1}	T/ \overline{R}	An	\overline{CS} at 0.8 V, V _{I(Bn)} = 0, V _L = 0, R _{L1} not connected, R _{L2} = 1.6 kΩ, C _L = 30 pF, See Figure 3	15		ns
t _{PLZ2}	\overline{CS}	An	Bn at 2 V, T/ \overline{R} at 0.8 V, C _L = 5 pF, V _L = 5 V, R _{L1} = 390 Ω, R _{L2} not connected, See Figure 5	18		ns
t _{PZL2}	\overline{CS}	An	Bn at 2 V, T/ \overline{R} at 0.8 V, C _L = 30 pF, V _L = 5 V, R _{L1} = 390 Ω, R _{L2} = 1.6 kΩ, See Figure 5	15		ns
t _{PHZ2}	\overline{CS}	An	Bn at 0.8 V, T/ \overline{R} at 0.8 V, C _L = 5 pF, V _L = 0, R _{L1} = 390 Ω, R _{L2} not connected, See Figure 5	8		ns
t _{PZH2}	\overline{CS}	An	Bn at 0.8 V, T/ \overline{R} at 0.8 V, C _L = 30 pF, V _L = 0, R _{L1} not connected, R _{L2} = 1.6 kΩ, See Figure 5	17		ns
t _{w(NR)}	Bn	An	\overline{CS} at 0.8 V, T/ \overline{R} at 0.8 V, R _{L1} = 390 Ω, R _{L2} = 1.6 kΩ, C _L = 30 pF, V _L = 5 V, See Figure 6	3		ns



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switching characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	SN75ALS057 DRIVER			UNIT
				MIN	TYP†	MAX	
t _{PLH1}	\overline{TE}	Bn	Dn, En, \overline{RE} at 2 V, V _L = 2 V, R _{L2} not connected, R _{L1} = 18 Ω, See Figure 2, C _L = 30 pF	24			ns
t _{PHL1}				20			
t _{PLH2}	Dn or En	Bn	\overline{TE} at 0.8 V, \overline{RE} at 2 V, V _L = 2 V, R _{L1} = 18 Ω, R _{L2} not connected, C _L = 30 pF, See Figure 2	19			ns
t _{PHL2}				18			
t _{TLH}	Dn or En	Bn	\overline{RE} at 2 V, V _L = 2 V, \overline{TE} at 0.8 V, R _{L1} = 18 Ω, R _{L2} not connected, C _L = 30 pF, See Figure 2	1	3	11	ns
t _{THL}				1	3	6	

† Typical values are at V_{CC} = 5 V, T_A = 25°C.

switching characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (continued)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	SN75ALS057 RECEIVER		UNIT
				MIN	MAX	
t _{PLH4}	Bn	Rn	\overline{RE} at 0.8 V, \overline{TE} at 2 V, V _L = 5 V, R _{L1} = 390 Ω, R _{L2} = 1.6 kΩ, C _L = 30 pF, See Figure 4	18		ns
t _{PHL4}				18		
t _{PLZ2}	\overline{RE}	Rn	Bn at 2 V, \overline{TE} at 2 V, V _L = 5 V, C _L = 5 pF, R _{L1} = 390 Ω, R _{L2} not connected, See Figure 5	18		ns
t _{PZL2}	\overline{RE}	Rn	Bn at 2 V, \overline{TE} at 2 V, V _L = 5 V, C _L = 30 pF, R _{L1} = 390 Ω, R _{L2} = 1.6 kΩ, See Figure 5	15		ns
t _{PHZ2}	\overline{RE}	Rn	Bn at 0.8 V, \overline{TE} at 2 V, V _L = 0, C _L = 5 pF, R _{L1} = 390 Ω, R _{L2} not connected, See Figure 5	17		ns
t _{PZH2}	\overline{RE}	Rn	Bn at 0.8 V, \overline{TE} at 2 V, V _L = 0, C _L = 30 pF, R _{L1} not connected, R _{L2} = 1.6 kΩ, See Figure 5	17		ns
t _{w(NR)}	Bn	Rn	\overline{TE} at 2 V, \overline{RE} at 0.8 V, V _L = 0, R _{L1} = 390 Ω, R _{L2} = 1.6 kΩ, C _L = 30 pF, See Figure 6	3		ns



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switching characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (continued)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	SN75ALS057 DRIVER PLUS RECEIVER		UNIT
				MIN	MAX	
t _{PLH6}	Dn	Rn	\overline{RE} at 0.8 V, \overline{TE} at 0.8 V, R _{L1} = 390 Ω, R _{L2} = 1.6 kΩ, C _L = 30 pF, See Figure 7	40		ns
t _{PHL6}				40		

PARAMETER MEASUREMENT INFORMATION

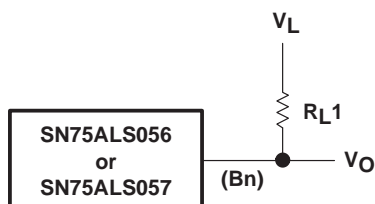
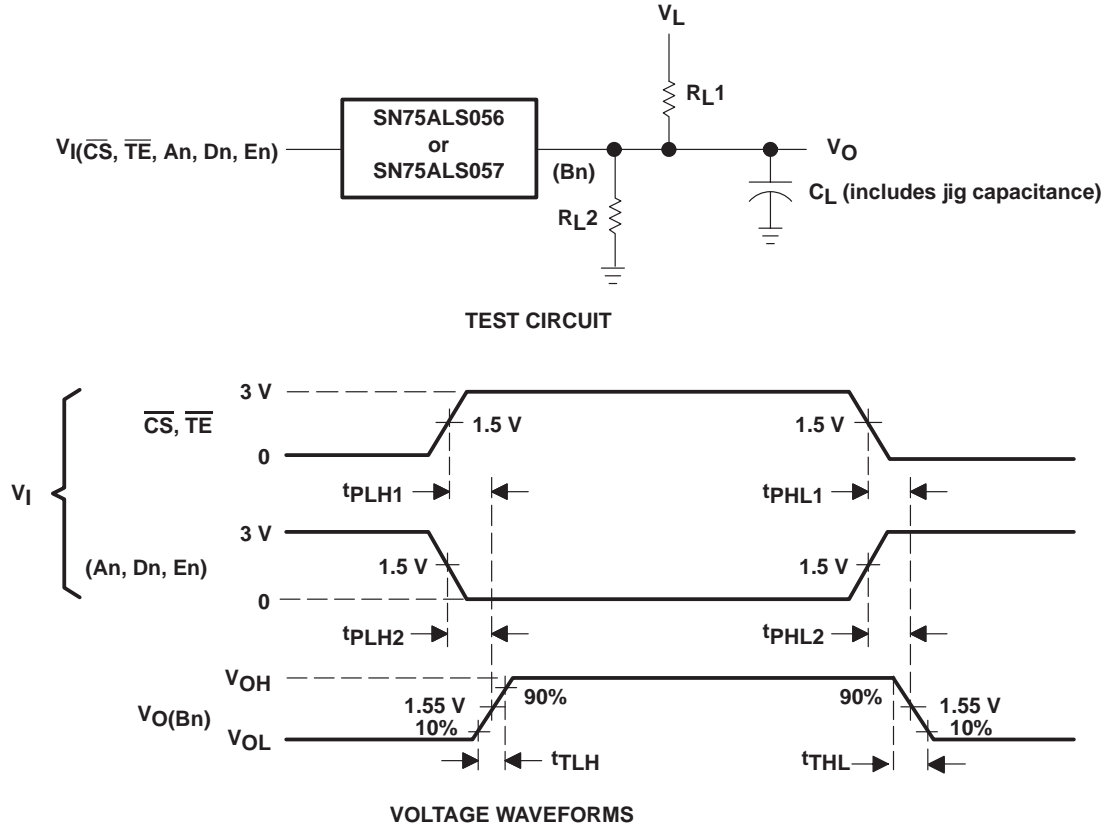


Figure 1. Driver Low-Level-Output-Voltage Test Circuit

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PARAMETER MEASUREMENT INFORMATION



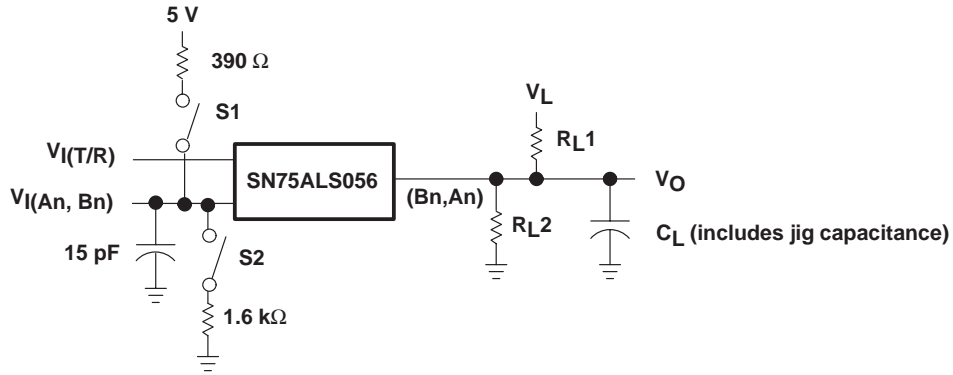
NOTE A: $t_r = t_f \leq 5$ ns from 10% to 90%

Figure 2. Driver Test Circuit and Voltage Waveforms

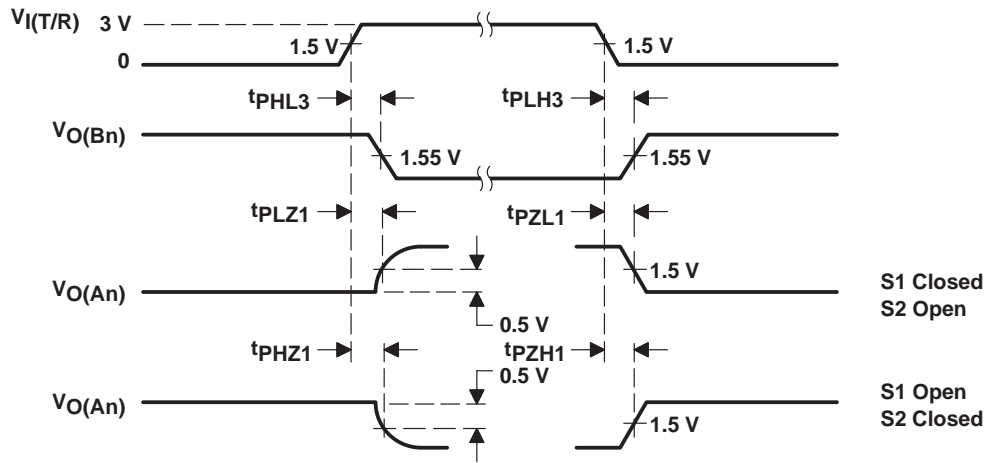
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PARAMETER MEASUREMENT INFORMATION



TEST CIRCUIT



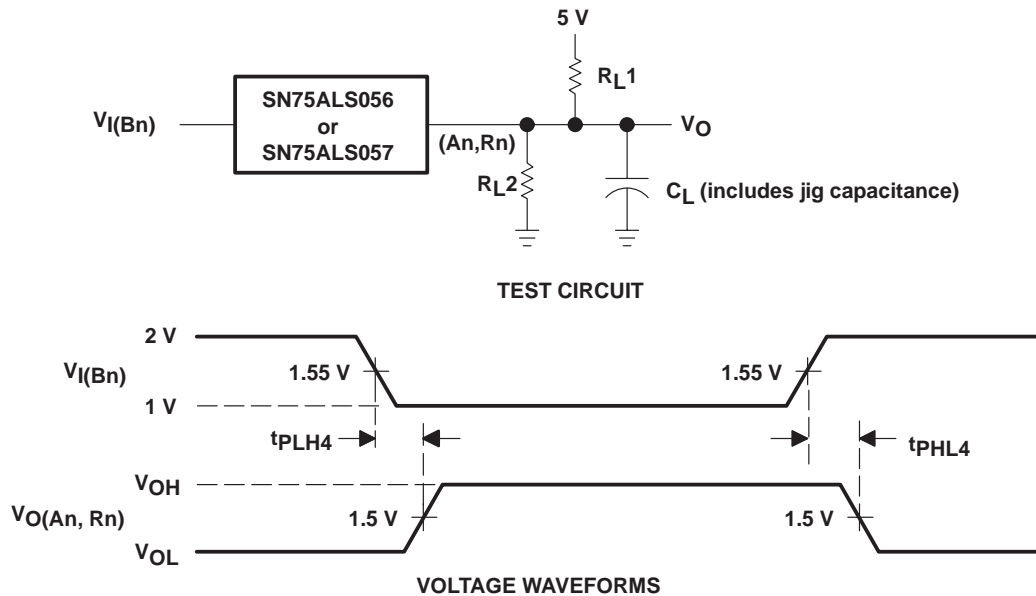
VOLTAGE WAVEFORMS

NOTE A: $t_r = t_f \leq 5$ ns from 10% to 90%

Figure 3. Propagation Delay From $\overline{T/R}$ to An or Bn Test Circuit and Voltage Waveforms

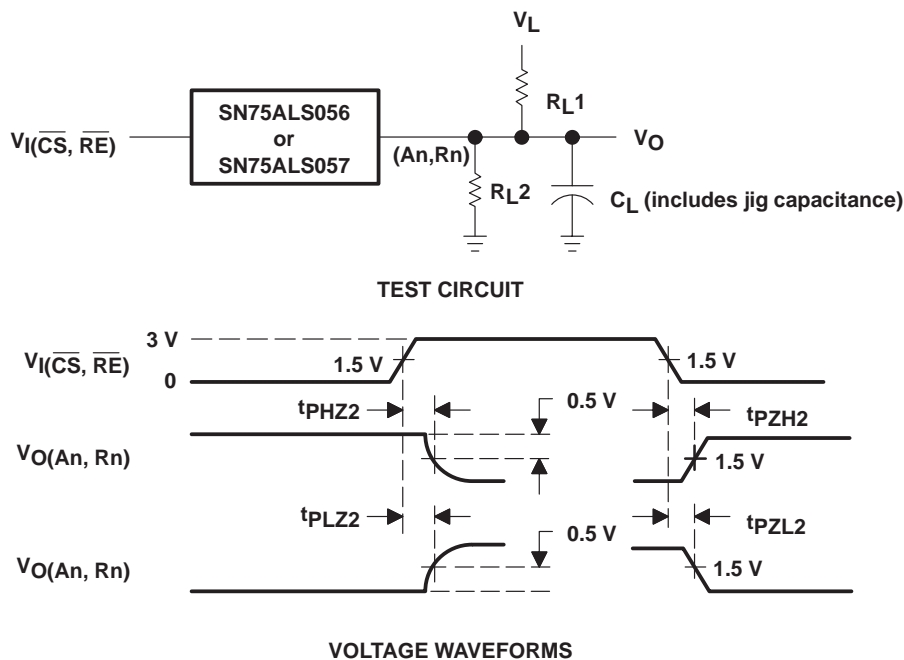
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NOTE A: $t_r = t_f \leq 5$ ns from 10% to 90%

Figure 4. Receiver Test Circuit and Voltage Waveforms



NOTE A: $t_r = t_f \leq 5$ ns from 10% to 90%

Figure 5. Propagation Delay From \overline{CS} to An or \overline{RE} to Rn Test Circuit and Voltage Waveforms

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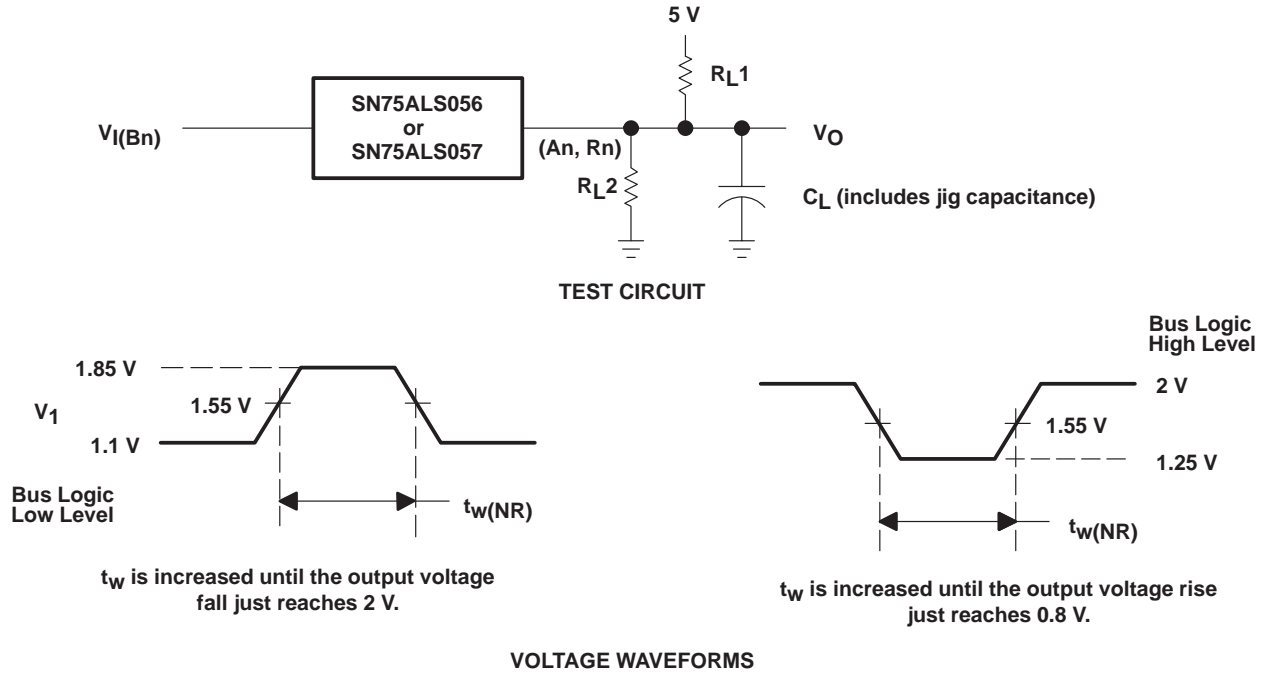


Figure 6. Receiver Noise-Immunity Test Circuit and Voltage Waveforms

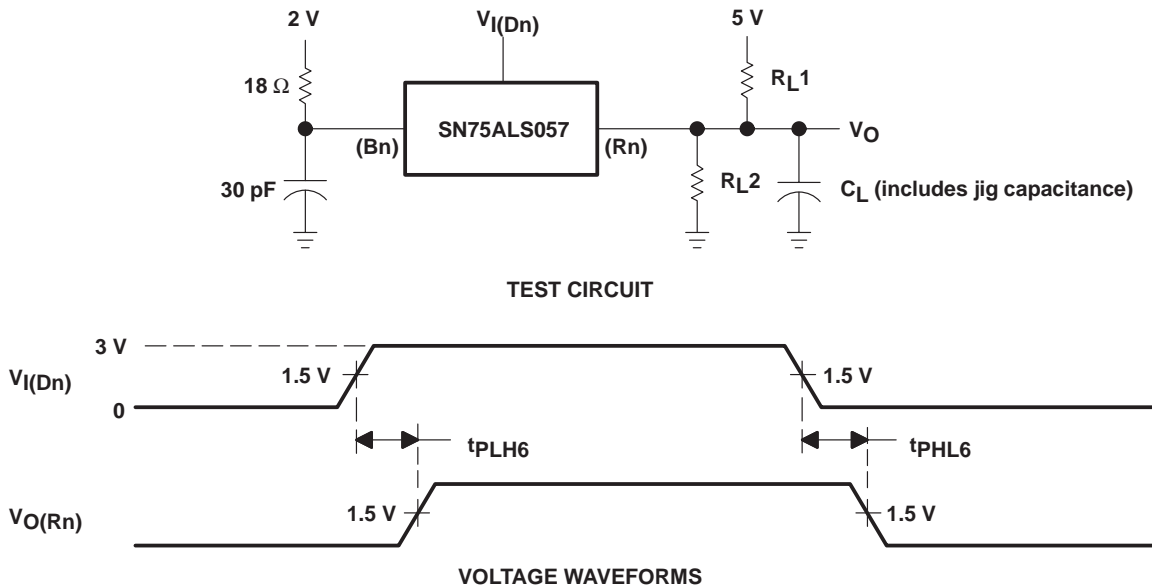


Figure 7. Driver Plus Receiver Delay-Times Test Circuits and Voltage Waveforms

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
SN75ALS056DW	ACTIVE	SOIC	DW	20	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	75ALS056	Samples
SN75ALS056DWR	ACTIVE	SOIC	DW	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	75ALS056	Samples
SN75ALS056N	ACTIVE	PDIP	N	20	20	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	0 to 70	SN75ALS056N	Samples
SN75ALS057DW	ACTIVE	SOIC	DW	20	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	75ALS057	Samples
SN75ALS057DWR	ACTIVE	SOIC	DW	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	75ALS057	Samples
SN75ALS057N	ACTIVE	PDIP	N	20	20	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	0 to 70	SN75ALS057N	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

⁽⁶⁾ Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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TAPE AND REEL INFORMATION



QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN75ALS056DWR	SOIC	DW	20	2000	330.0	24.4	10.8	13.3	2.7	12.0	24.0	Q1
SN75ALS057DWR	SOIC	DW	20	2000	330.0	24.4	10.8	13.3	2.7	12.0	24.0	Q1

TAPE AND REEL BOX DIMENSIONS


*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN75ALS056DWR	SOIC	DW	20	2000	367.0	367.0	45.0
SN75ALS057DWR	SOIC	DW	20	2000	367.0	367.0	45.0

N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
 - The 20 pin end lead shoulder width is a vendor option, either half or full width.

DW0020A



PACKAGE OUTLINE

SOIC - 2.65 mm max height

SOIC



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NOTES:

1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.43 mm per side.
5. Reference JEDEC registration MS-013.

EXAMPLE BOARD LAYOUT

DW0020A

SOIC - 2.65 mm max height

SOIC



LAND PATTERN EXAMPLE
SCALE:6X



SOLDER MASK DETAILS

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NOTES: (continued)

- 6. Publication IPC-7351 may have alternate designs.
- 7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

EXAMPLE STENCIL DESIGN

DW0020A

SOIC - 2.65 mm max height

SOIC



SOLDER PASTE EXAMPLE
BASED ON 0.125 mm THICK STENCIL
SCALE:6X

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NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

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